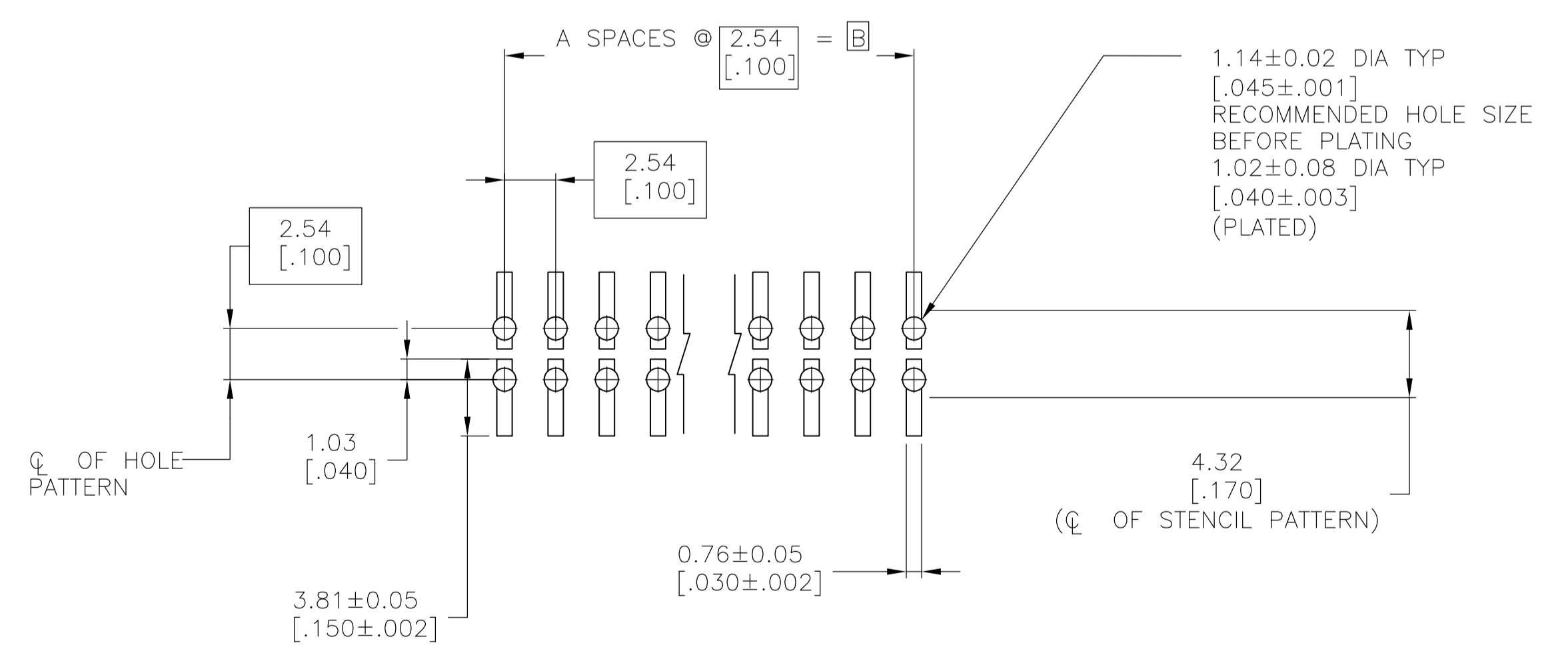
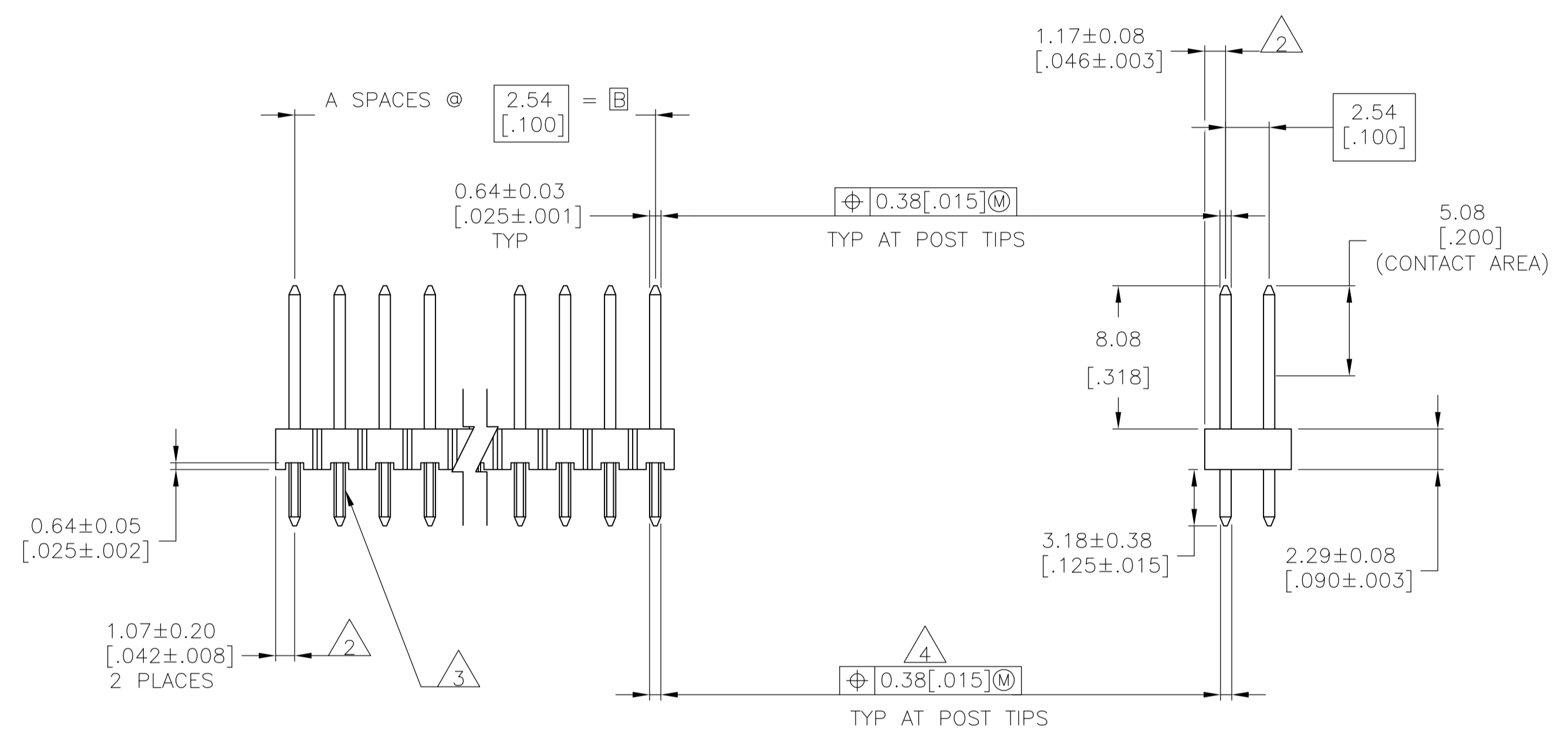


- 1 TRUE POSITION TOLERANCE OF THE POST TIPS APPLIES WHEN THE HEADER IS HELD FLAT AGAINST THE PRINTED CIRCUIT BOARD.
- 2 THE NOTED DIMENSIONS APPLY AT THE INTERSECTION OF THE POST AND HOUSING.
- 3 RETENTION FEATURES ON SOLDER TAILS, LOCATED AT MANUFACTURERS OPTION.
- 4 $\text{M} \text{ } \phi 0.51 \text{ } [0.020]$ FOR KINKED TAILS.
- 5 HOUSING: LCP, COLOR-BLACK. POST: PHOSPHOR BRONZE.
- 6 0.000076[.0000030] MIN GOLD OVER 0.00068[.000027] Pd/Ni IN CONTACT AREA, 0.00254-0.00508 [.0000100-.0000200] MATTE TIN ON SOLDER TAIL, ALL OVER 0.00127 [.000050] NICKEL.



RECOMMENDED PC BOARD MOUNTING DIMENSIONS FOR 1.60[.063] THICK PC BOARD AND 0.305[.0120] STENCIL THICK

6	101.19 [3.984]	99.06 [3.900]	39	80	8-1977951-0
6	2.13 [.084]	-	-	2	1977951-2
PLATING	C	B	A	NO. OF POSITIONS	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm [INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED:	DRAWING NO.	SCALE	SHEET	REV
0 PLC ± -	1 PLC ± -	31AUG2013	4:1	1	1
2 PLC ± 0.51[.02]	3 PLC ± 0.12[.005]	31AUG2013			
4 PLC ± 0.012[.0005]	ANGLES ± -				
MATERIAL	FINISH	WEIGHT	SIZE	CAGE CODE	DRAWING NO.
5	SEE TABLE	-	A1	00779	1977951
CUSTOMER DRAWING			RESTRICTED TO		

STE TE Connectivity

NAME: KIRAN HOLAL
 CHK: MIKE MILLER
 APVD: MIKE MILLER
 PRODUCT SPEC: HEADER ASSEMBLY, MOD II, BREAKAWAY, DOUBLE ROW, .100 X.100 CL, VERTICAL, WITH RETENTION FEATURE, .025 SQ.POSTS, HIGH TEMPERATURE, 30 Pd/Ni

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)